

L Number	Hits	Search Text	DB	Time stamp
3	1	("5406124").PN.	USPAT	2001/12/17 04:34
4	284316	adhesive	USPAT	2001/12/17 04:34
5	23080	acrylic same epoxy	USPAT	2001/12/17 04:34
6	215	chip same die adj pad same adhesive	USPAT	2001/12/17 04:35
7	9	(acrylic same epoxy) and (chip same die adj pad same adhesive)	USPAT	2001/12/17 04:36
8	128647	silicone	USPAT	2001/12/17 04:36
9	4564	(acrylic same epoxy) same silicone	USPAT	2001/12/17 04:36
10	5	((acrylic same epoxy) same silicone) and (chip same die adj pad same adhesive)	USPAT	2001/12/17 04:39
11	0	"030012781"	JPO; DERWENT	2001/12/17 04:40
14	0	"03.0012781"	JPO; DERWENT	2001/12/17 04:40
17	1	"03012781"	JPO; DERWENT	2001/12/17 04:40
20	1	("3012781").PN.	USPAT	2001/12/17 04:41
23	0	("30012781").PN.	USPAT	2001/12/17 04:41
24	0	("30012781").PN.	USPAT	2001/12/17 04:41
25	1	("3012781").PN.	USPAT	2001/12/17 04:41
-	1	("5667899").PN.	USPAT	2001/12/17 03:45
-	1	("5406124").PN.	USPAT	2001/12/15 19:42
-	952	diaminophenyl	USPAT	2001/12/15 19:42
-	140	diaminophenyl adj ether	USPAT	2001/12/15 20:10
-	243956	bis(4-amino-3,5-dimethylphenyl)methane	USPAT	2001/12/15 20:55
-	2262060	@ad<19950706 @riad<19950706	USPAT	2001/12/15 20:14
-	85	(@ad<19950706 @riad<19950706) and (chip same die adj pad same adhesive)	USPAT	2001/12/15 20:14
-	265263	4,4-diaminophenyl ether	USPAT	2001/12/15 21:02
-	31	(4,4-diaminophenyl ether) and (chip same die adj pad same adhesive)	USPAT	2001/12/15 20:16
-	243952	bis(4-amino-3,5-diisopropylphenyl)methane	USPAT	2001/12/15 20:56

-	8	((@ad<19950706 @riad<19950706) and (chip same die adj pad same adhesive)) and ((4,4-diaminophenyl ether) and (chip same die adj pad same adhesive)) and ((bis(4-amino-3,5-diisopropylphenyl)methane) and (chip same die adj pad same adhesive))	USPAT	2001/12/15 20:17
-	6018	peel! adj strength	USPAT	2001/12/15 20:17
-	6	(((@ad<19950706 @riad<19950706) and (chip same die adj pad same adhesive)) and ((4,4-diaminophenyl ether) and (chip same die adj pad same adhesive)) and ((bis(4-amino-3,5-diisopropylphenyl)methane) and (chip same die adj pad same adhesive))) and (peel! adj strength)	USPAT	2001/12/15 20:18
-	407470	(temperature temp) same pressure	USPAT	2001/12/15 20:26
-	6	(((((ad<19950706 @riad<19950706) and (chip same die adj pad same adhesive)) and ((4,4-diaminophenyl ether) and (chip same die adj pad same adhesive)) and ((bis(4-amino-3,5-diisopropylphenyl)methane) and (chip same die adj pad same adhesive))) and (peel! adj strength)) and ((temperature temp) same pressure)	USPAT	2001/12/15 20:26
-	243956	bis 4-amino-3,5-dimethylphenyl methane	USPAT	2001/12/15 20:57
-	243952	bis 4-amino-3,5-diisopropylphenyl methane	USPAT	2001/12/15 20:58
-	27	(chip same die adj pad same adhesive) and (bis 4-amino-3,5-dimethylphenyl methane)	USPAT	2001/12/15 20:56
-	27	(chip same die adj pad same adhesive) and (bis 4-amino-3,5-diisopropylphenyl methane)	USPAT	2001/12/15 20:56
-	27	((chip same die adj pad same adhesive) and (bis 4-amino-3,5-dimethylphenyl methane)) and ((chip same die adj pad same adhesive) and (bis 4-amino-3,5-diisopropylphenyl methane)) and ((bis(4-amino-3,5-diisopropylphenyl)methane) and (chip same die adj pad same adhesive))	USPAT	2001/12/15 20:57
-	0	(bis adj 4-amino-3,5-dimethylphenyl adj methane) and ((bis(4-amino-3,5-diisopropylphenyl)methane) and (chip same die adj pad same adhesive))	USPAT	2001/12/15 20:58
-	0	(bis adj 4-amino-3,5-dimethylphenyl adj methane) and (bis adj 4-amino-3,5-diisopropylphenyl adj methane)	USPAT	2001/12/15 20:58
-	0	(bis adj 4-amino-3,5-diisopropylphenyl adj methane) and ((bis(4-amino-3,5-diisopropylphenyl)methane) and (chip same die adj pad same adhesive))	USPAT	2001/12/15 20:58
-	2	bis adj 4-amino-3,5-diisopropylphenyl adj methane	USPAT	2001/12/15 20:58

-	27	(bis(4-amino-3,5-dilsopropylphenyl)methane) and (chip same die adj pad same adhesive)	USPAT	2001/12/15 21:01
-	0	(bis adj 4-amino-3,5-dimethylphenyl adj methane) and (chip same die adj pad same adhesive)	USPAT	2001/12/15 21:01
-	96	4,4-diaminophenyl adj ether	USPAT	2001/12/15 21:02
-	0	(4,4-diaminophenyl adj ether) and (chip same die adj pad same adhesive)	USPAT	2001/12/15 21:02
-	284316	adhesive	USPAT	2001/12/15 21:02
-	32	adhesive and (4,4-diaminophenyl adj ether)	USPAT	2001/12/15 21:03
-	42	bis adj 4-amino-3,5-dimethylphenyl adj methane	USPAT	2001/12/16 22:17
-	215	chip same die adj pad same adhesive	USPAT	2001/12/16 22:15
-	0	(bis adj 4-amino-3,5-dimethylphenyl adj methane) and (chip same die adj pad same adhesive)	USPAT	2001/12/16 22:15
-	2	semiconductor and (bis adj 4-amino-3,5-dimethylphenyl adj methane)	USPAT	2001/12/16 22:16
-	348305	integrated	USPAT	2001/12/16 22:16
-	1	integrated and (bis adj 4-amino-3,5-dimethylphenyl adj methane)	USPAT	2001/12/16 22:16
-	284316	adhesive	USPAT	2001/12/16 22:17
-	31	(bis adj 4-amino-3,5-dimethylphenyl adj methane) and adhesive	USPAT	2001/12/16 22:18